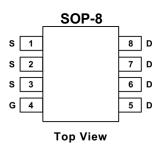
IRF7341TRPBF-HX P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
Vos (V)	Id (A)			
60	0.040 at Vgs = - 10 V	7		
	0.055 at Vgs = 4.5 V	1		

FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g Tested





Absolute Maximum Ratings T _A =25°C unless otherwise noted					
Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain	T _A =25°C	D	4.5		
Current AF	T _A =70°C	טו	3.6	Α	
Pulsed Drain Current ^B		I _{DM}	20		
	T _A =25°C	Po	2	W	
Power Dissipation	T _A =70°C	ı D	1.28	VV	
Avalanche Current ^B		$I_{AR,}I_{AS}$	19	А	
Repetitive avalanche energy 0.1mH ^B		E _{AR} , E _{AS}	18	mJ	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C	

Thermal Characteristics					
Parameter	Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{ heta JA}$	48	62.5	°C/W
Maximum Junction-to-Ambient A	Steady-State	- AJA	74	110	°C/W
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	35	60	°C/W

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Flectrical Characteristics (T.I=25° C unless otherwise noted)							
Symbol	Parameter	Conditions	Min	Tvp	Max	Units	
STATIC F	STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I _D =250μA,V _{GS} =0V	60			V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V,V _{GS} =0V			1	^	
DSS	Zero Gate Voltage Drain Current	Tյ=55°C			5	μΑ	
I_{GSS}	Gate-Body leakage current	V _{DS} =0V,V _{GS} =±20V			100	nΑ	
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =250μA	1	2.1	3	V	
I _{D(ON)}	On state drain current	V _{GS} =10V,V _{DS} =5V	20			Α	
		V _{GS} =10V,I _D =4.5A		46	56	m()	
R _{DS(ON)}	Static Drain-Source On-Resistance	T _J =125°C		80	100	mΩ	
, ,		V _{GS} =4.5V,I _D =3A		64	77	mΩ	
g _{FS}	Forward Transconductance	V_{DS} =5 V , I_{D} =4.5 A		11		S	
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.74	1	V	
Is	Maximum Body-Diode Continuous Current				3	Α	
I_{SM}	Pulsed Body Diode Current ^B				20	Α	
DYNAMIO	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V,		450	540	pF	
C_{oss}	Output Capacitance	V _{DS} =30V,		60		pF	
C_{rss}	Reverse Transfer Capacitance	f=1MHz		25		pF	
R_g	Gate resistance	V _{GS} =0V,V _{DS} =0V,f=1MHz	1.3	1.65	2	Ω	
SWITCHI	SWITCHING PARAMETERS						
Q _q (10V)	Total Gate Charge	V 40V		8.5	10.5	nC	
Qg(4.5V)	Total Gate Charge	V _{GS} =10V,		4.3	5.5	nC	
Q_{as}	Gate Source Charge	V _{DS} =30V,		1.6		nC	
Q_{ad}	Gate Drain Charge	150 001,		2.2		nC	
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V,		4.7		ns	
t _r	Turn-On Rise Time	V _{DS} =30V,	7	2.3		ns	
t _{D(off)}	Turn-Off DelayTime	R _L =6.7Ω,		15.7		ns	
t _f	Turn-Off Fall Time	Rom=30		1.9		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =4.5A,dI/dt=100A/μs		27.5	35	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =4.5A,dI/dt=100A/μs		32		nC	

NOTE

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A.The value of R $_{\text{MA}}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_{\text{A}}$ =25°C. The value in any given application depends on the user's specific board design. B.Repetitive rating, pulse width limited by junction temperature. C.The R $_{\text{MA}}$ is the sum of the thermal impedence from junction to lead R $_{\text{ML}}$ and lead to ambient.

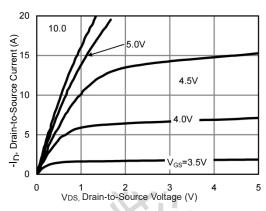
D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

E.These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T _A=25°C. The SQA curve provides a single pulse rating.

F.The current rating is based on the t≤ 10s junction to ambient thermal resistance rating.

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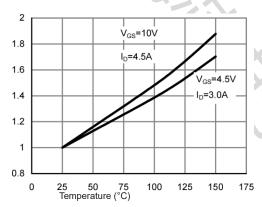
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2 2.5 3 3.5 4 4.5 5
VGS, Gate-to-Source Voltage (V)

Fig 1. Typical Output Characteristics

Fig 2. Typical Transfer Characteristics



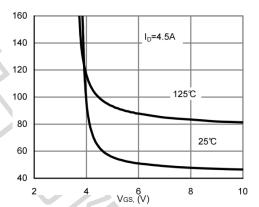
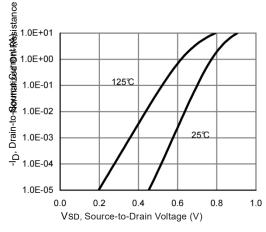


Fig 3.On-Resistance vs. Junction Temperature

Fig 4. On-Resistance vs. Gate-Source Voltage



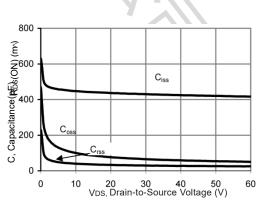


Fig 5. Typical Source-Drain Diode Forward Voltage

Fig 6. Typical Capacitance Vs.

Drain-to-Source Voltage

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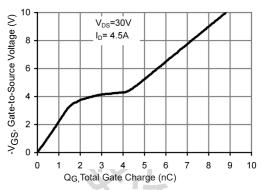


Fig 7. Gate Charge Characteristics

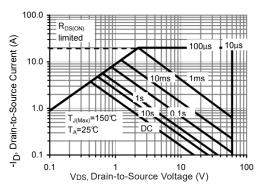


Fig 8.Maximum Safe Operating Area(Note E)

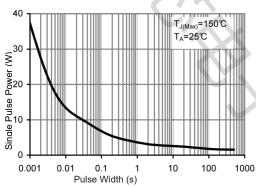


Fig 9. Single Pulse Power Rating Junction-to- Ambient (Note E)

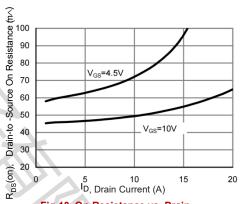


Fig 10. On-Resistance vs. Drain Current and Gate Voltage

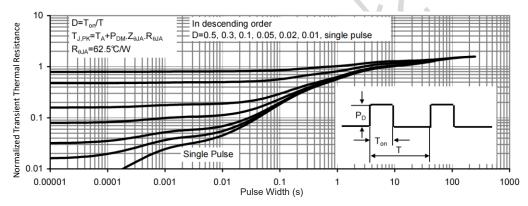
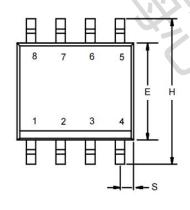


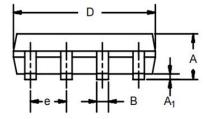
Fig 11. Normalized Maximum Transient Thermal Impedance

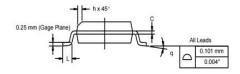
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SOP-8 Package Outline

Dimensions are shown in millimeters (inches)



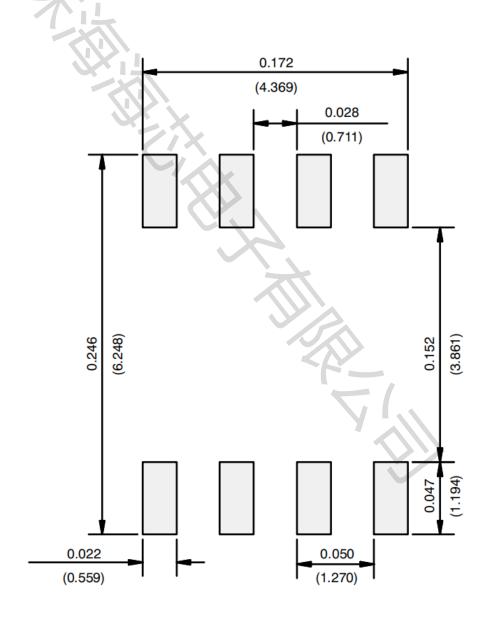




	MILLII	METERS		INCHES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A1	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.007 5	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	

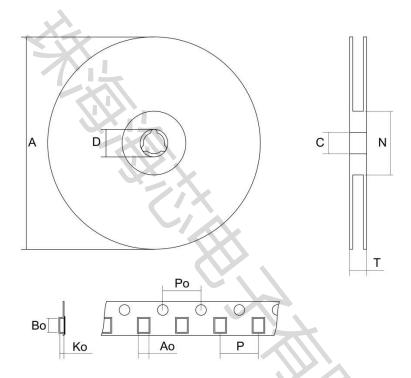
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RECOMMENDED MINIMUM PADS FOR SOP-8

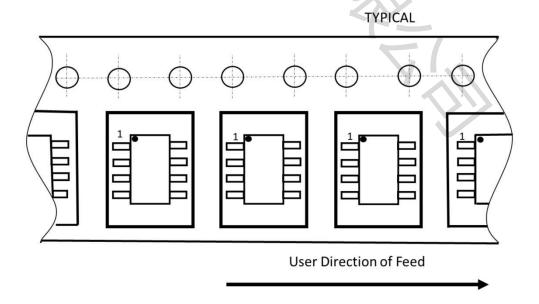


SOP-8 packing information

SOP-8 tape and reel



Tape orientation



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